

#### **DUAL N-CHANNEL ENHANCEMENT MODE MOSFET**

# **Product Summary**

BVDSS	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>A</sub> = +25°C
30V	$3\Omega$ @ $V_{GS} = 4.5V$	250 m A
307	7Ω @ V <sub>GS</sub> = 2.5V	350 mA

## **Description**

This MOSFET has been designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## **Applications**

- Motor controls
- · Power management functions
- DC-DC converters
- Backlighting

### SOT563





Top View

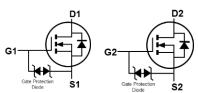
## **Features and Benefits**

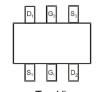
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DIODES™ DMN33D8LVQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

#### **Mechanical Data**

- Package: SOT563
- Package Material: Molded Plastic, "Green" Molding Compound UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.006 grams (Approximate)





Internal Schematic

Top View Pin Out

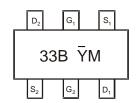
## **Ordering Information** (Note 4)

Part Number	Pankaga	Packing		
Fait Number	Package	Qty.	Carrier	
DMN33D8LVQ-7	SOT563	3,000	Tape & Reel	
DMN33D8LVQ-13	SOT563	10,000	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



33B = Product Type Marking Code YM = Date Code Marking Y = Year (ex: J = 2022)

M = Month (ex: 6 = June)

Date Code Key

Year	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033
Code	J	K	L	М	N	0	Р	R	S	T	U	V
Month	Jan	Feb	Mar	Apr	May	lun	Jul	Aug	Sep	Oct	Nov	Dec
onti	Jan	Len	IVIAI	Λþi	iviay	Jun	Jui	Aug	ОСР	06	1101	200
Code	1	2	3	4	5	6	7	8	9	0	N	D



## **Maximum Ratings** (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage			VDSS	30	V
Gate-Source Voltage			V <sub>GSS</sub>	±20	V
Continuous Drain Current (Note 5) $V_{GS} = 4.5V$ Steady $T_A = +25^{\circ}C$ State $T_A = +70^{\circ}C$			I <sub>D</sub>	350 200	mA
Maximum Continuous Body Diode Forward Currer	nt (Note 5)	Is	0.5	А	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1	%)		Ірм	0.8	А

## Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Total Dawer Discipation (Note 5)	T <sub>A</sub> = +25°C	D-	0.43	W	
Total Power Dissipation (Note 5)	T <sub>A</sub> = +70°C	PD	0.20		
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R <sub>θJA</sub>	288	°C/W	
Operating and Storage Temperature Range	·	TJ, TSTG	-55 to +150	°C	

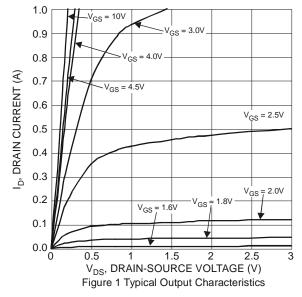
# **Electrical Characteristics** (@TA = +25°C, unless otherwise specified.)

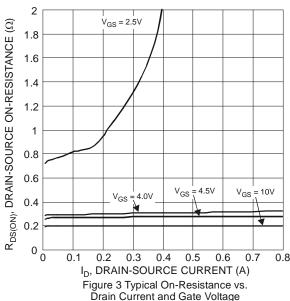
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	30	_	_	V	$V_{GS} = 0V$ , $I_D = 1mA$
Zero Gate Voltage Drain Current @Tc = +25°C	IDSS	_	_	1	μA	V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V
Gate-Source Leakage	Igss	_	_	±10	μΑ	$V_{GS} = \pm 16V$ , $V_{DS} = 0V$
ON CHARACTERISTICS (Note 6)						
Gate Threshold Voltage	VGS(th)	0.8		1.5	V	$V_{DS} = 3V$ , $I_{D} = 100 \mu A$
		_		2.4		$V_{GS} = 10V, I_{D} = 250mA$
Static Drain-Source On-Resistance	Descent	_	_	3.0	Ω	$V_{GS} = 4.5V, I_D = 250mA$
Static Dialii-Source Off-Resistance	RDS(ON)	_	_	5.0	12	V <sub>G</sub> S = 4.0V, I <sub>D</sub> = 10mA
		_	_	7.0		$V_{GS} = 2.5V, I_{D} = 5mA$
Diode Forward Voltage	V <sub>SD</sub>	_	_	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 115mA
DYNAMIC CHARACTERISTICS (Note 7)						
Input Capacitance			48		pF	., 5,, ,,
Output Capacitance	Coss	_	11	_	pF	$V_{DS} = 5V, V_{GS} = 0V,$ -f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	8	_	pF	1 = 1.0WHZ
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	0.55	_	nC	
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	1.23	_	nC	Vgs = 10V, Vps = 10V,
Gate-Source Charge	Qgs	_	0.14	_	nC	$I_D = 250 \text{mA}$
Gate-Drain Charge	Qgd	_	0.14	_	nC	
Turn-On Delay Time	t <sub>D(on)</sub>	_	2.9	_	ns	
Turn-On Rise Time	tr	_	2.6	_	ns	V <sub>DD</sub> = 30V, V <sub>GS</sub> = 10V,
Turn-Off Delay Time		_	18.2	_	ns	$R_G = 25\Omega$ , $I_D = 200mA$
Turn-Off Fall Time	tf	_	13.6	_	ns	

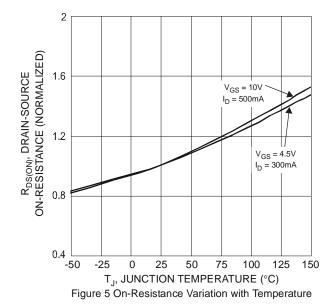
5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.6. Short duration pulse test used to minimize self-heating effect.7. Guaranteed by design. Not subject to product testing. Notes:

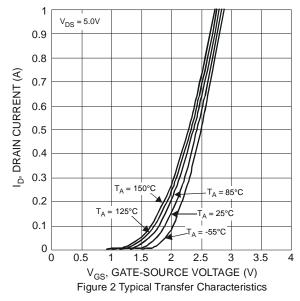


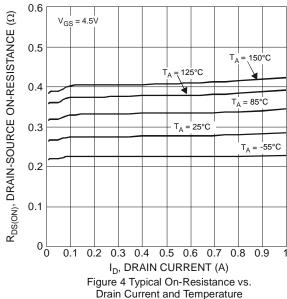












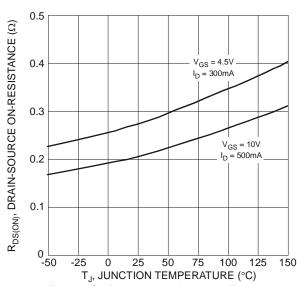


Figure 6 On-Resistance Variation with Temperature





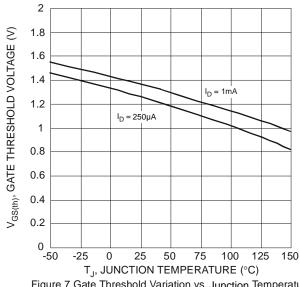
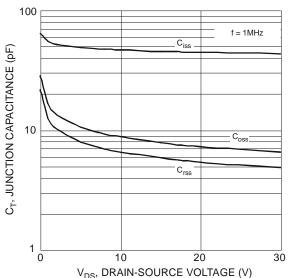


Figure 7 Gate Threshold Variation vs. Junction Temperature



V<sub>DS</sub>, DRAIN-SOURCE VOLTAGE (V) Figure 9 Typical Junction Capacitance

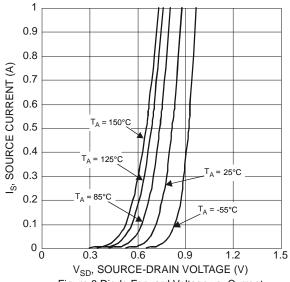
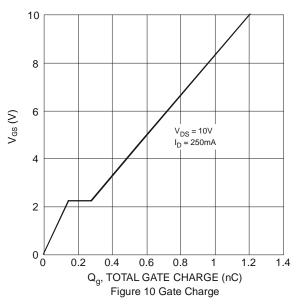


Figure 8 Diode Forward Voltage vs. Current



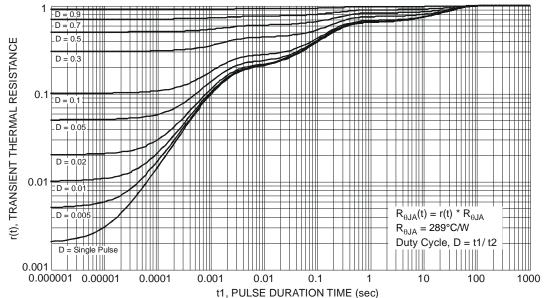


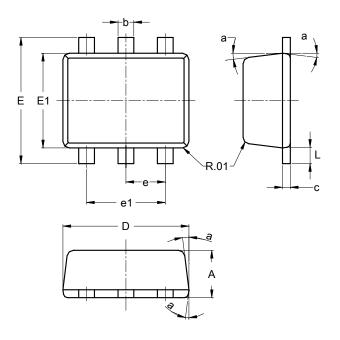
Figure 11 Transient Thermal Resistance



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### **SOT563**

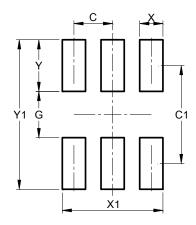


SOT563							
Dim	Min	Max	Тур				
Α	0.55	0.60					
b	0.15	0.30	0.20				
С	0.10	0.18	0.11				
D	1.50	1.70	1.60				
Е	1.55	1.70	1.60				
E1	1.10	1.25	1.20				
е			0.50				
e1	0.90	1.10	1.00				
L	0.10	0.30	0.20				
а	8°	9°	7°				
All Dimensions in mm							

# Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### **SOT563**



Dimensions	Value (in mm)
С	0.500
C1	1.270
G	0.600
Х	0.300
X1	1.300
Y	0.670
Y1	1 940



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